February 2008

MM74HCT04 Hex Inverter

Features

■ TTL, LS pin-out and threshold compatible

■ Fast switching: t_{PLH}, t_{PHL}=12 ns (typ)

■ Low power: 10 µW at DC, 3.7 mW at 5 MHz

■ High fanout: ≥ 10 LS loads
 ■ Inverting, triple buffered

General Description

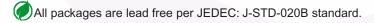
The MM74HCT04 is a logic function fabricated by using advanced silicon-gate CMOS technology which provides the inherent benefits of CMOS—low quiescent power and wide power supply range. This device is input and output characteristic as well as pin-out compatible with standard 74LS logic families. The MM74HCT04, triple buffered, hex inverters, features low power dissipation and fast switching times. All inputs are protected from static discharge by internal diodes to $V_{\rm CC}$ and ground.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug-in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

Ordering Information

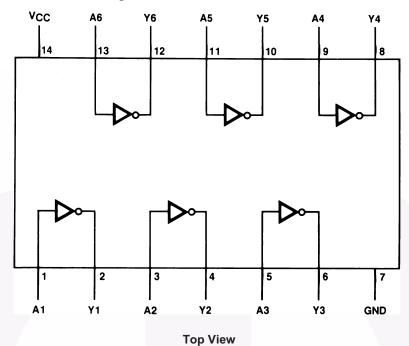
Order Number	Package Number	Package Description
MM74HCT04M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HCT04SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HCT04MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HCT04N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.



Connection Diagram

Pin Assignments for DIP, SOIC, SOP and TSSOP



Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5 to +7.0V
V _{IN}	DC Input Voltage	-1.5 to V _{CC} +1.5V
V _{OUT}	DC Output Voltage	-0.5 to V _{CC} +0.5V
I _{IK} , I _{OK}	Clamp Diode Current	±20mA
I _{OUT}	DC Output Current, per pin	±25mA
I _{CC}	DC V _{CC} or GND Current, per pin	±50mA
T _{STG}	Storage Temperature Range	−65°C to +150°C
P _D	Power Dissipation Note 2	600mW
	S.O. Package only	500mW
TL	Lead Temperature (Soldering 10 seconds)	260°C

Notes:

- 1. Unless otherwise specified all voltages are referenced to ground.
- 2. Power Dissipation temperature derating plastic "N" package: -12mW/°C from 65°C to 85°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter		Max.	Units
V _{CC}	Supply Voltage	4.5	5.5	V
V _{IN} , V _{OUT}	DC Input or Output Voltage		V _{CC}	V
T _A	Operating Temperature Range		+85	°C
t _r , t _f	Input Rise or Fall Times		500	ns

DC Electrical Characteristics

 $V_{CC} = 5V \pm 10\%$ (unless otherwise specified)

			T _A	= 25°C	T _A = -40°C to 85°C	T _A = -55°C to 125°C	
Symbol	Parameter	Conditions	Тур.	G	uaranteed Li	mits	Units
V _{IH}	Minimum HIGH Level Input Voltage			2.0	2.0	2.0	V
V_{IL}	Maximum LOW Level Input Voltage			0.8	0.8	0.8	V
V _{OH}	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} = 20\mu\text{A}$	V _{CC}	V _{CC} – 0.1	V _{CC} – 0.1	V _{CC} - 0.1	V
		$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} = 4.0\text{mA},$ $V_{CC} = 4.5\text{V}$	4.2	3.98	3.84	3.7	
		$V_{IN} = V_{IH}$ or V_{IL} , $ I_{OUT} = 4.8$ mA, $V_{CC} = 5.5$ V	5.2	4.98	4.84	4.7	
V _{OL}	Maximum LOW Level Voltage	$V_{IN} = V_{IH},$ $ I_{OUT} = 20\mu A$	0	0.1	0.1	0.1	V
		$\begin{aligned} & V_{\text{IN}} = V_{\text{IH}}, \\ & I_{\text{OUT}} = 4.0 \text{mA}, \\ & V_{\text{CC}} = 4.5 \text{V} \end{aligned}$	0.2	0.26	0.33	0.4	
		$\begin{aligned} & V_{\text{IN}} = V_{\text{IH}}, \\ & I_{\text{OUT}} = 4.8 \text{mA}, \\ & V_{\text{CC}} = 5.5 \text{V} \end{aligned}$	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND, V_{IH} or V_{IL}		±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0\mu A$		2.0	20	40	μA
		$V_{IN} = 2.4 \text{V or } 0.5 \text{V}^{(3)}$		0.3	0.4	0.5	mA

Note:

3. This is measured per input with all other inputs held at $\rm V_{\rm CC}$ or ground.

AC Electrical Characteristics

 V_{CC} = 5.0V, t_r = t_r = 6ns, C_L = 15pF, T_A = 25°C (unless otherwise noted)

Symbol	Parameter	Conditions	Тур.	Guaranteed Limit	Units
t_{PLH} , t_{PHL}	Maximum Propagation Delay		10	18	ns

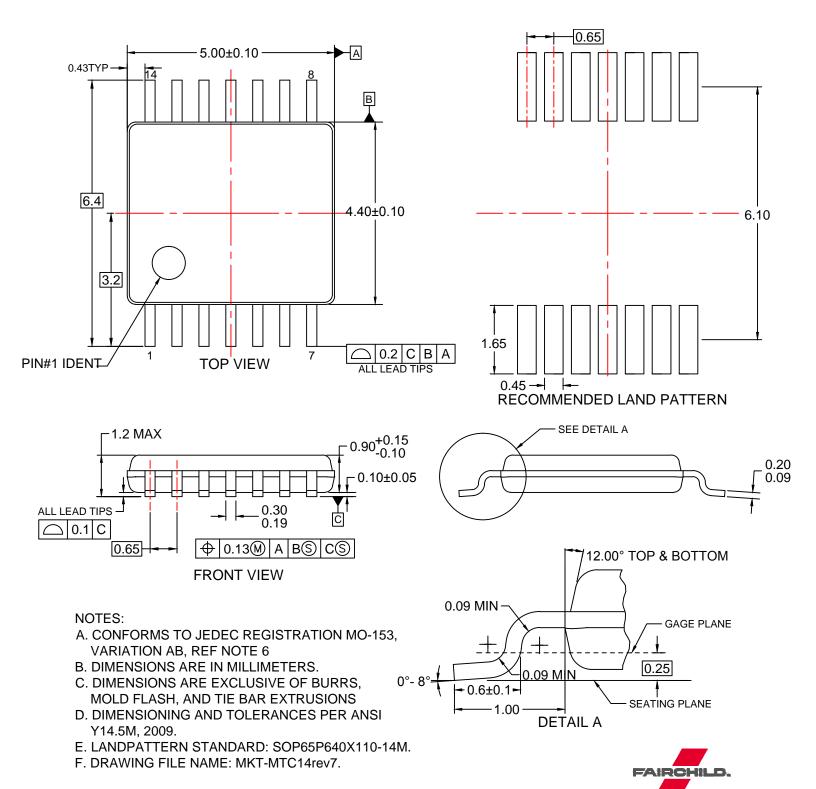
AC Electrical Characteristics

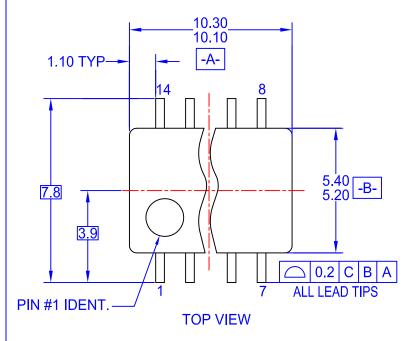
 V_{CC} = 5.0V ±10%, t_r = t_f = 6ns, C_L = 50pF (unless otherwise noted)

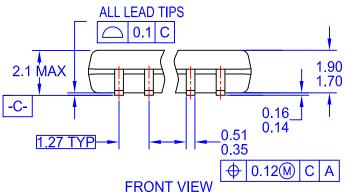
			T _A =	25°C	T _A = -40°C to 85°C	T _A = -55°C to 125°C	
Symbol	Parameter	Conditions	Тур.		Guaranteed Limits		Units
t _{PLH} , t _{PHL}	Maximum Propagation Delay		14	20	25	30	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time		8	15	19	22	ns
C _{PD}	Power Dissipation Capacitance	(4)	20				pF
C _{IN}	Input Capacitance		5	10	10	10	pF

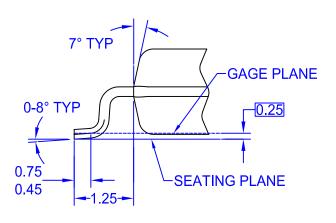
Note:

4. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

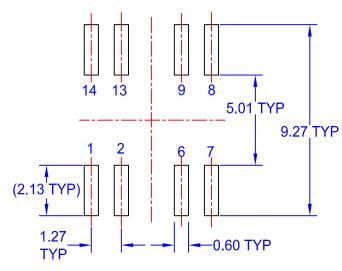




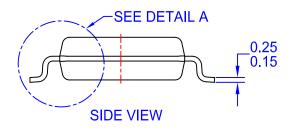




DETAIL A



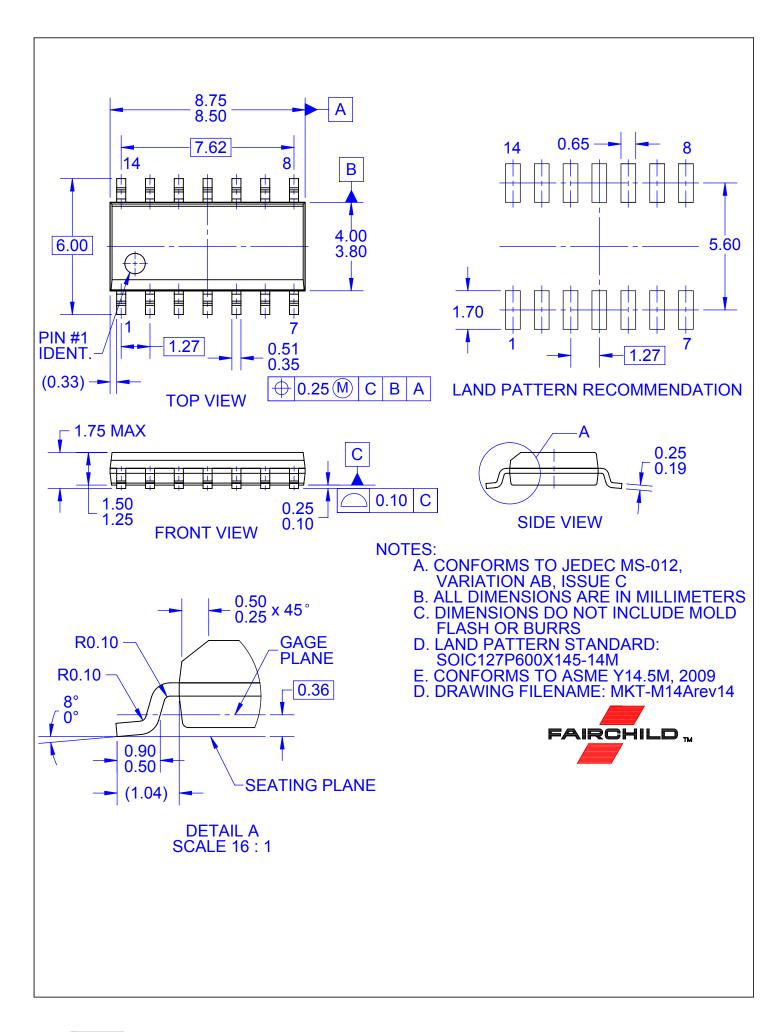
LAND PATTERN RECOMMENDATION



NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DRAWING FILENAME: MKT-M14Drev4.





ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hol

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910

Phone: 421 33 790 2910

Japan Customer Focus Center

Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

www.onsemi.com